

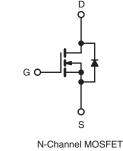
RoHS

COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 5.0 V 0.27			
Q <sub>g</sub> (Max.) (nC)	12			
Q <sub>gs</sub> (nC)	3.0			
Q <sub>gd</sub> (nC)	7.1			
Configuration	Single			





#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(on)}$  Specified at  $V_{GS} = 4 V$  and 5 V
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL520PbF
	SiHL520-E3
SnPb	IRL520
	SiHL520

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	100	V
Gate-Source Voltage			V <sub>GS</sub>	± 10	- V
Continuous Drain Current	V <sub>GS</sub> at 5.0 V	T <sub>C</sub> = 25 °C	I <sub>D</sub> -	9.2	
	V <sub>GS</sub> at 5.0 V	T <sub>C</sub> = 100 °C		6.5	A
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	36	
Linear Derating Factor				0.40	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	170	mJ
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	9.2	A
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	6.0	mJ
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	60	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	
Mounting Torque	6.20 or 1	12 001014		10	lbf ∙ in
Mounting Torque	6-32 or M3 screw			1.1	N · m

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 3.0 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 9.2 \text{ A}$  (see fig. 12).

c.  $I_{SD} \leq 9.2$  A, dI/dt  $\leq 110$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^{\circ}C.$ 

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91298 S11-0518-Rev. B, 21-Mar-11 www.vishay.com

## IRL520, SiHL520

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greasd Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	2.5	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	1.0	-	2.0	V	
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 10 V	-	-	± 100	nA	
Zene Oete Veltere Durin Orment	1	V <sub>DS</sub> =	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25	<u> </u>	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 80 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA	
	_	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 5.5 A <sup>b</sup>	-	-	0.27	+	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 4.0 V$	I <sub>D</sub> = 4.6 A <sup>b</sup>	-	-	0.38	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	= 50 V, I <sub>D</sub> = 5.5 A	3.2	-	-	S	
Dynamic								
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V,$	-	490	-	pF	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 V,$	-	150	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	30	-		
Total Gate Charge	Qg			-	-	12		
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 5.0 V$	I <sub>D</sub> = 9.2 A, V <sub>DS</sub> = 80 V, see fig. 6 and 13 <sup>b</sup>	-	-	3.0	nC	
Gate-Drain Charge	Q <sub>gd</sub>		see lig. o and to	-	-	7.1	1	
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.8	-		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, I <sub>D</sub> = 9.2 A, R <sub>g</sub> = 9.0 Ω, R <sub>D</sub> = 5.2 Ω, see fig. 10 <sup>b</sup>		-	64	-	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	21	-		
Fall Time	t <sub>f</sub>			-	27	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	nH	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.2	Α	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	36		
Body Diode Voltage	$V_{SD}$	$T_J = 25 \ ^{\circ}C, \ I_S = 9.2 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 9.2 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}^b$		-	130	190	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.83	1.0	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 

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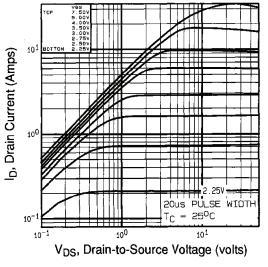


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

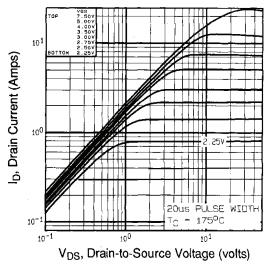


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

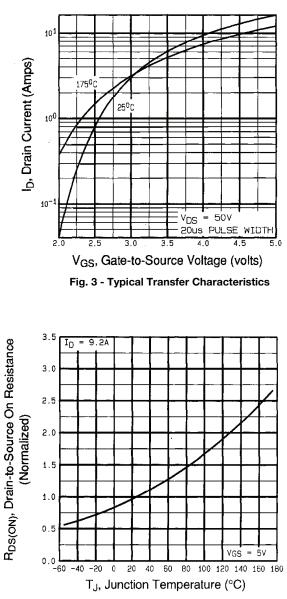


Fig. 4 - Normalized On-Resistance vs. Temperature

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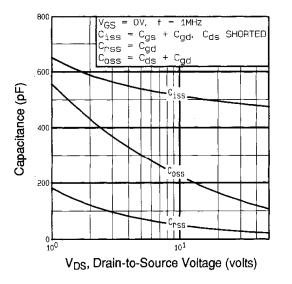
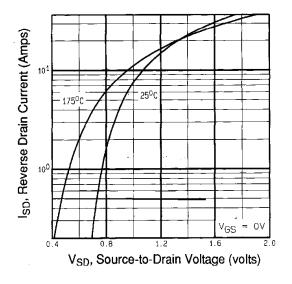
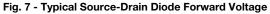


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





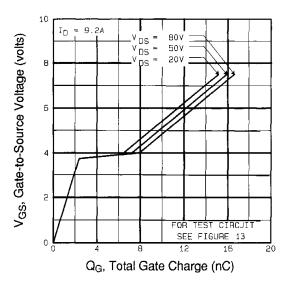


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

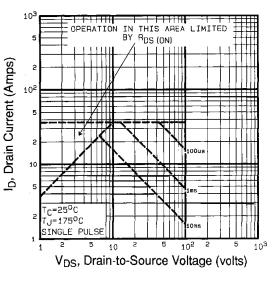


Fig. 8 - Maximum Safe Operating Area

Document Number: 91298 S11-0518-Rev. B, 21-Mar-11



### IRL520, SiHL520

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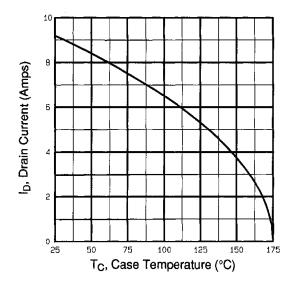


Fig. 9 - Maximum Safe Operating Area

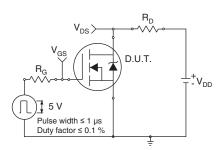


Fig. 10a - Switching Time Test Circuit

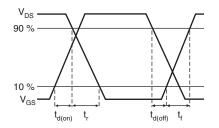


Fig. 10b - Switching Time Waveforms

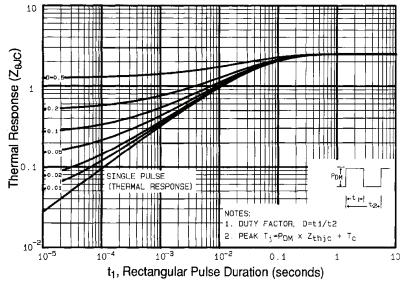


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



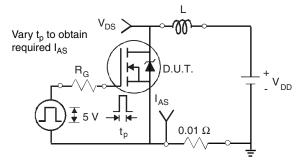


Fig. 12a - Unclamped Inductive Test Circuit

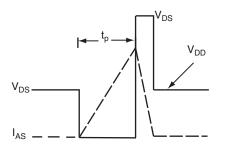


Fig. 12b - Unclamped Inductive Waveforms

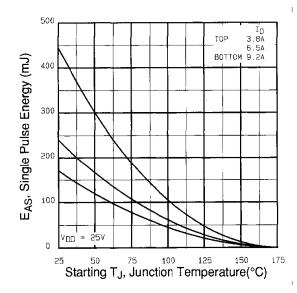


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

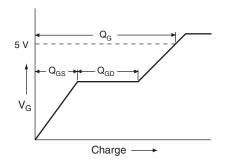


Fig. 13a - Basic Gate Charge Waveform

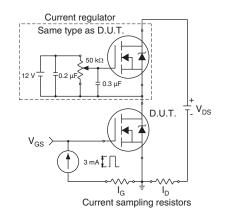
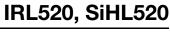


Fig. 13b - Gate Charge Test Circuit

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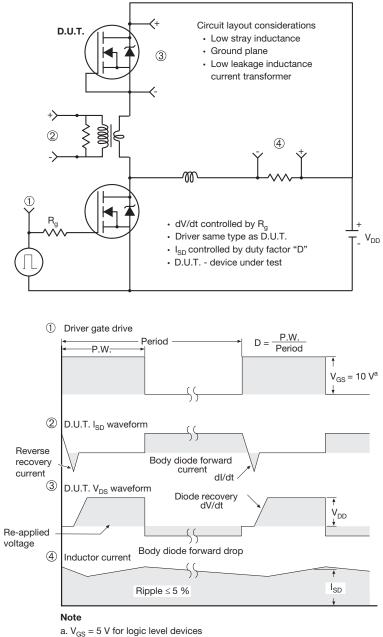


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES	
DIN.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØР	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031				

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
AS	ASE		'an	
		IRF 9510 744K AB		

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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